

P-Channel Power MOSFET

-30V, -3A, 60mΩ

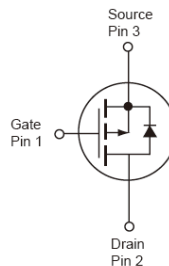
Features

- Advance Trench Process Technology
- High Density Cell Design for Ultra Low On-resistance
- Pb-free plating
- RoHS compliant
- Halogen-free package

Application

- Load Switch
- PA Switch

| KEY PERFORMANCE PARAMETERS | | | |
|----------------------------|------------------|-------|------|
| PARAMETER | | VALUE | UNIT |
| V_{DS} | | -30 | V |
| $R_{DS(on)}$ (max) | $V_{GS} = -10V$ | 60 | mΩ |
| | $V_{GS} = -4.5V$ | 90 | |
| Q_g | | 9.52 | nC |



P-Channel MOSFET

Notes: Moisture sensitivity level: level 3. Per J-STD-020

| ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ unless otherwise noted) | | | | |
|---|--------------------|----------------|--------------|------------|
| PARAMETER | | SYMBOL | LIMIT | UNIT |
| Drain-Source Voltage | | V_{DS} | -30 | V |
| Gate-Source Voltage | | V_{GS} | ± 20 | V |
| Continuous Drain Current ^(Note 1) | $T_A = 25^\circ C$ | I_D | -3 | A |
| Pulsed Drain Current ^(Note 2) | | I_{DM} | -10 | A |
| Continuous Source Current (Diode Conduction) | | I_S | -1.9 | A |
| Total Power Dissipation | $T_A = 25^\circ C$ | P_{TOT} | 1.25 | W |
| | $T_A = 70^\circ C$ | | 0.8 | |
| Operating Junction and Storage Temperature Range | | T_J, T_{STG} | - 55 to +150 | $^\circ C$ |

| THERMAL PERFORMANCE | | | |
|--|-----------------|-------|--------------|
| PARAMETER | SYMBOL | LIMIT | UNIT |
| Junction to Case Thermal Resistance | $R_{\theta JC}$ | 75 | $^\circ C/W$ |
| Junction to Ambient Thermal Resistance | $R_{\theta JA}$ | 100 | $^\circ C/W$ |

Notes: $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case thermal reference is defined at the solder mounting surface of the drain pins. $R_{\theta JA}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design. $R_{\theta JA}$ shown below for single device operation on FR-4 PCB in still air.

| ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted) | | | | | | |
|---|---|--------------|------|--------|-----------|------------|
| PARAMETER | CONDITIONS | SYMBOL | MIN | TYP | MAX | UNIT |
| Static ^(Note 3) | | | | | | |
| Drain-Source Breakdown Voltage | $V_{GS} = 0V, I_D = -250\mu A$ | BV_{DSS} | -30 | -- | -- | V |
| Gate Threshold Voltage | $V_{DS} = V_{GS}, I_D = -250\mu A$ | $V_{GS(TH)}$ | -1.0 | -1.5 | -3.0 | V |
| Gate Body Leakage | $V_{GS} = \pm 20V, V_{DS} = 0V$ | I_{GSS} | -- | -- | ± 100 | nA |
| Zero Gate Voltage Drain Current | $V_{DS} = -24V, V_{GS} = 0V$ | I_{DSS} | -- | -- | -1 | μA |
| On-State Drain Current | $V_{DS} = -5V, V_{GS} = -10V$ | $I_{D(ON)}$ | -6 | -- | -- | A |
| Drain-Source On-State Resistance | $V_{GS} = -10V, I_D = -3A$ | $R_{DS(ON)}$ | -- | 50 | 60 | m Ω |
| | $V_{GS} = -4.5V, I_D = -2A$ | | -- | 75 | 90 | |
| Forward Transconductance | $V_{DS} = -15V, I_D = -5A$ | g_{fs} | 4 | 7 | -- | S |
| Dynamic ^(Note 4) | | | | | | |
| Total Gate Charge | $V_{DS} = -15V, I_D = -3A,$ $V_{GS} = -10V$ | Q_g | -- | 9.52 | -- | nC |
| Gate-Source Charge | | Q_{gs} | -- | 3.43 | -- | |
| Gate-Drain Charge | | Q_{gd} | -- | 1.71 | -- | |
| Input Capacitance | $V_{DS} = -15V, V_{GS} = 0V,$ $f = 1.0\text{MHz}$ | C_{iss} | -- | 551.57 | -- | pF |
| Output Capacitance | | C_{oss} | -- | 90.96 | -- | |
| Reverse Transfer Capacitance | | C_{rss} | | | 60.79 | |
| Switching ^(Note 5) | | | | | | |
| Turn-On Delay Time | $V_{DD} = -15V,$ $R_{GEN} = 6\Omega,$ $I_D = -1A, V_{GS} = -10V,$ | $t_{d(on)}$ | -- | 10.8 | -- | ns |
| Turn-On Rise Time | | t_r | -- | 2.33 | -- | |
| Turn-Off Delay Time | | $t_{d(off)}$ | -- | 22.53 | -- | |
| Turn-Off Fall Time | | t_f | -- | 3.87 | -- | |
| Source-Drain Diode ^(Note 3) | | | | | | |
| Forward On Voltage | $I_S = -1.9 A, V_{GS} = 0V$ | V_{SD} | -- | -0.8 | -1.3 | V |

Notes:

1. Pulse width limited by the maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 5$ sec.
3. Pulse test: $PW \leq 300\mu s$, duty cycle $\leq 2\%$.
4. For DESIGN AID ONLY, not subject to production testing.
5. Switching time is essentially independent of operating temperature.

ORDERING INFORMATION

| PART NO. | PACKAGE | PACKING |
|-----------------|----------------|--------------------|
| TSM3401CX RFG | SOT-23 | 3,000pcs / 7" Reel |

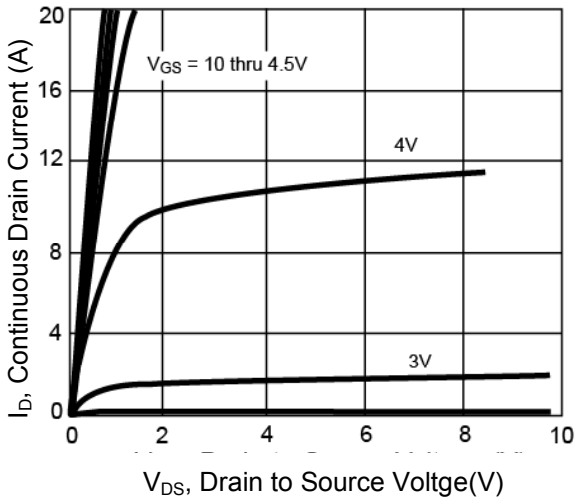
Note:

1. Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
2. Halogen-free according to IEC 61249-2-21 definition

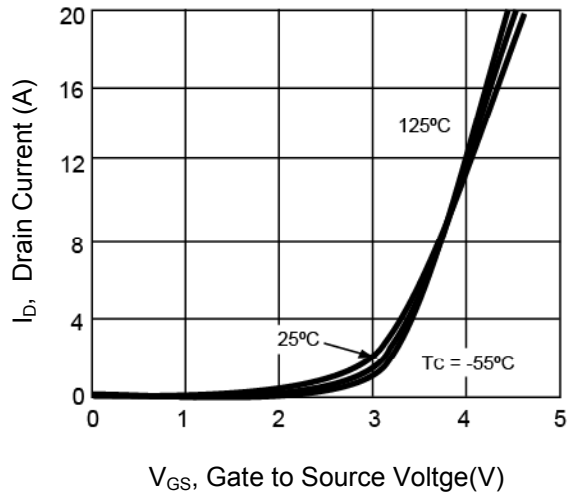
CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

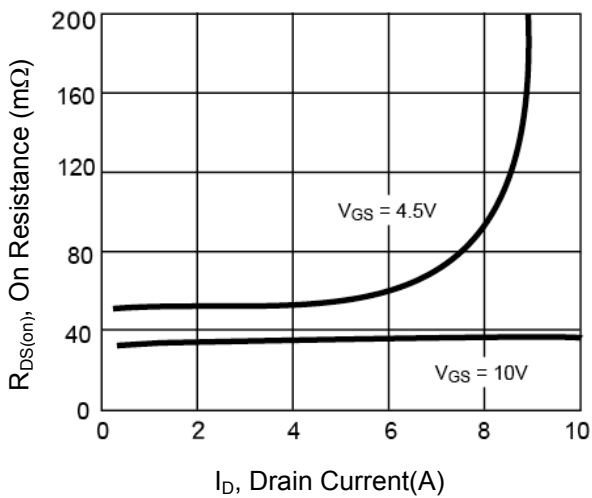
Output Characteristics



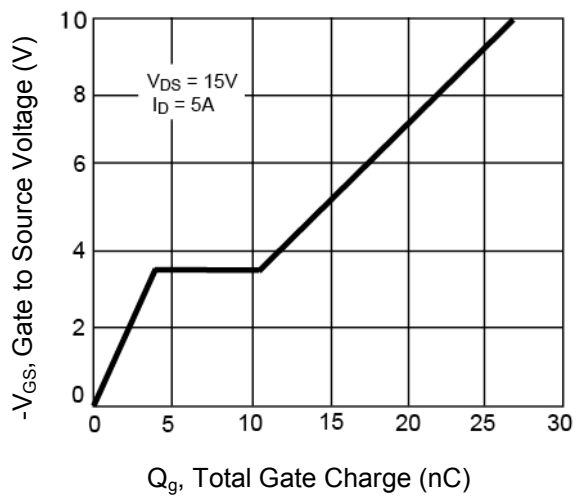
Transfer Characteristics



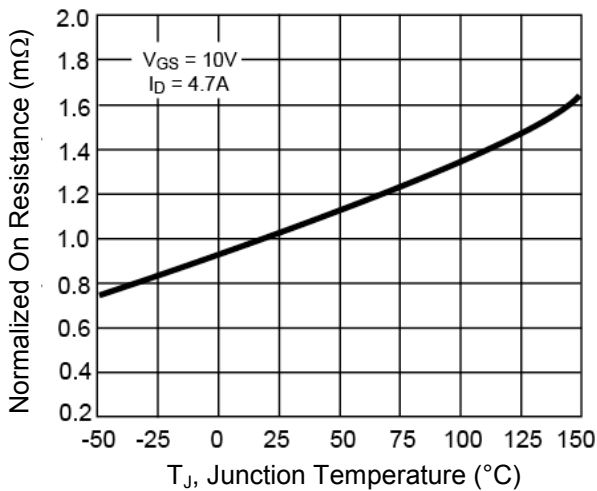
On-Resistance vs. Drain Current



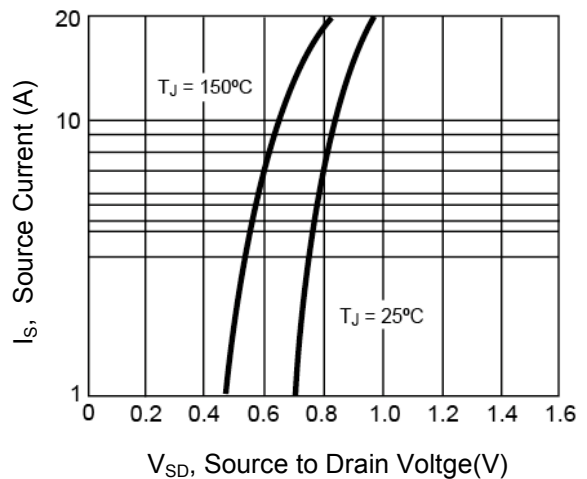
Gate Charge



On-Resistance vs. Junction Temperature



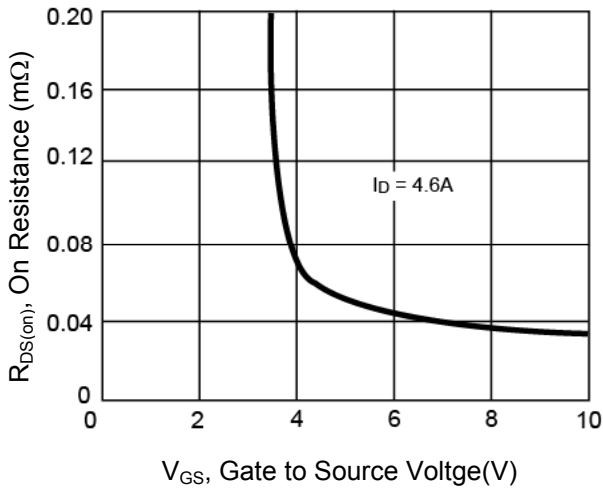
Source-Drain Diode Forward Voltage



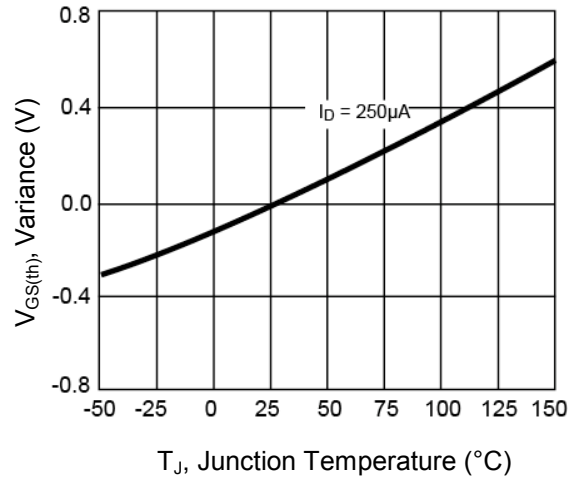
CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

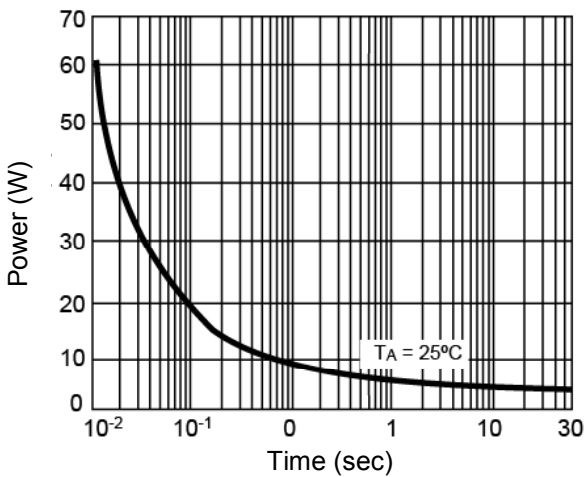
On-Resistance vs. Gate-Source Voltage



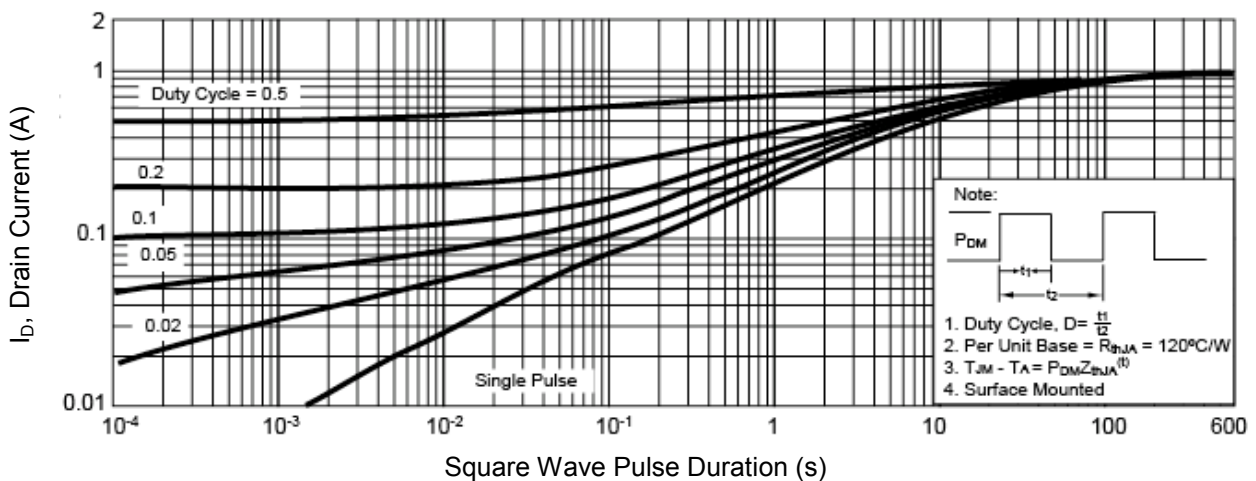
Threshold Voltage



Single Pulse Power

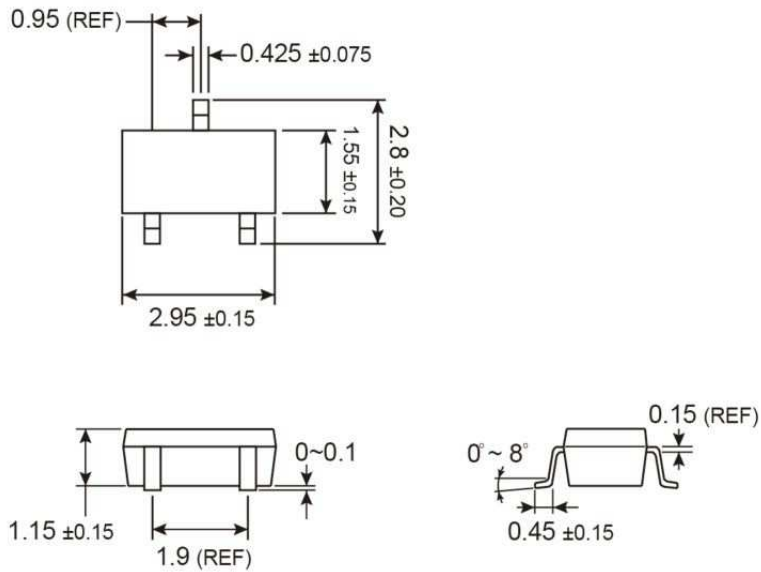


Normalized Thermal Transient Impedance Curve

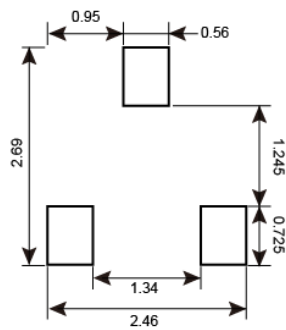


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

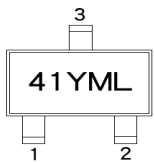
SOT-23



SUGGESTED PAD LAYOUT (Unit: Millimeters)



MARKING DIAGRAM



- Y** = Year Code
- M** = Month Code for Halogen Free Product
 - O** =Jan **P** =Feb **Q** =Mar **R** =Apr
 - S** =May **T** =Jun **U** =Jul **V** =Aug
 - W** =Sep **X** =Oct **Y** =Nov **Z** =Dec
- L** = Lot Code (1~9, A~Z)

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Taiwan Semiconductor:](#)

[TSM3401CX](#) [TSM3401CX RFG](#)